National Semiconductor

F100325
Low Power Hex ECL-to-TTL Translator

General Description

The F100325 is a hex translator for converting F100K logic levels to TTL logic levels. Differential inputs allow each circuit to be used as an inverting, non-inverting or differential receiver. An internal reference voltage generator provides V_{BB} for single-ended operation, or for use in Schmitt trigger applications. All inputs have 50kΩ pull-down resistors. When the inputs are either unconnected or at the same potential the outputs will go low.

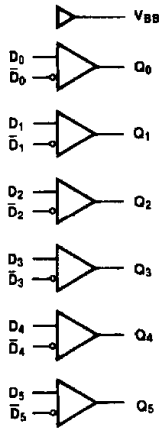
When used in single-ended operation the apparent input threshold of the true inputs is 20mV to 40mV higher (positive) than the threshold of the complementary inputs. The V_{EE} and V_{TTL} power may be applied in either order.

Features

- Pin/function compatible with F100125
- Meets F100125 AC specifications
- 50% power reduction of the F100125
- Differential inputs with built in offset
- Standard FAST® outputs
- 2000V ESD protection
- −4.2V to −5.7V operating range

Ordering Code: See Section 8

Logic Diagram

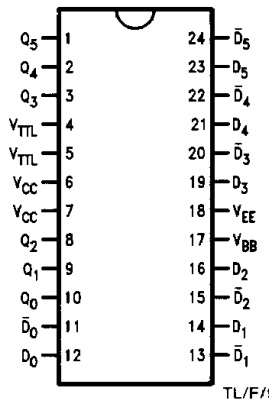


TL/F/9879–4

Pin Names	Description
D_0–D_5	Data Inputs
$\overline{D}_0$–$\overline{D}_5$	Inverting Data Inputs
Q_0–Q_5	Data Outputs

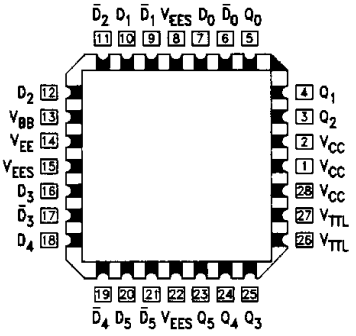
Connection Diagrams

24-Pin DIP



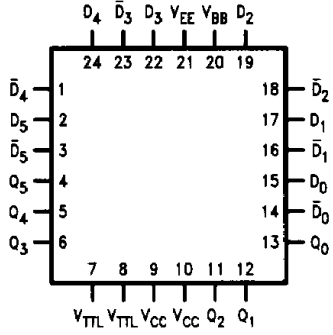
TL/F/9879–1

28-Pin PCC



TL/F/9879–3

24-Pin Quad Cerpak



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Absolute Maximum Ratings

Above which the useful life may be impaired. (Note 1)

If Military/Aerospace specified devices are required, please contact the National Semiconductor Sales Office/Distributors for availability and specifications.

Storage Temperature (T_{STG})	−65°C to +150°C
Maximum Junction Temperature (T_J)	
Ceramic	+175°C
Plastic	+150°C
V_{EE} Pin Potential to Ground Pin	−7.0V to +0.5V
V_{TTL} Pin Potential to Ground Pin	+6.0V to −0.5V
Input Voltage (DC)	V_{EE} to +0.5V
Output Current (DC Output HIGH)	−50 mA
ESD (Note 2)	≥2000V

Recommended Operating Conditions

Case Temperature (T_C)	
Commercial	0°C to +85°C
Military	−55°C to +125°C
Supply Voltage (V_{EE})	
Commercial	−5.7V to −4.2V
Military	−5.7V to −4.2V

DC Electrical Characteristics

V_{EE} = −4.2V to −5.7V, V_{CC} = GND, T_C = 0°C to +85°C (Note 3)

Symbol	Parameter	Min	Typ	Max	Units	Conditions	
V_{BB}	Output Reference Voltage	−1380	−1320	−1260	mV	I_{VBB} = −2.1 mA	
V_{IH}	Single-Ended Input HIGH Voltage	−1165		−870	mV	Guaranteed HIGH Signal for All Inputs (with One Input Tied to V_{BB})	
V_{IL}	Single-Ended Input LOW Voltage	−1830		−1475	mV	Guaranteed LOW Signal for All Inputs (with One Input Tied to V_{BB})	
V_{OH}	Output HIGH Voltage	2.5			V	I_{OH} = −2.0 mA	V_{IN} = $V_{IH\ (Max)}$ or $V_{IL\ (Min)}$
V_{OL}	Output LOW Voltage			0.5	V	I_{OL} = 20 mA	
V_{DIFF}	Input Voltage Differential	150			mV	Required for Full Output Swing	
V_{CM}	Common Mode Voltage	V_{CC} − 2.0		V_{CC} − 0.5	V		
I_{IH}	Input HIGH Current			350	μA	V_{IN} = $V_{IH\ (Max)}$, D_0–D_5 = V_{BB}, $\overline{D}_0$–$\overline{D}_5$ = $V_{IL\ (Min)}$	
I_{IL}	Input LOW Current	0.5			μA	V_{IN} = $V_{IL\ (Min)}$, D_0–D_5 = V_{BB}	
I_{OS}	Output Short-Circuit Current	−150		−60	mA	V_{OUT} = GND*	
I_{EE}	V_{EE} Power Supply Current	−37	−27	−17	mA	D_0–D_5 = V_{BB}	
I_{TTL}	V_{TTL} Power Supply Current		45	65	mA	D_0–D_5 = V_{BB}	

*Test one output at a time.

Note 1: Absolute maximum ratings are those values beyond which the device may be damaged or have its useful life impaired. Functional operation under these conditions is not implied.

Note 2: ESD testing conforms to MIL-STD-883, Method 3015.

Note 3: The specified limits represent the "worst case" value for the parameter. Since these values normally occur at the temperature extremes, additional noise immunity and guardbanding can be achieved by decreasing the allowable system operating ranges. Conditions for testing shown in the tables are chosen to guarantee operation under "worst case" conditions.

Ceramic Dual-In-Line Package AC Electrical Characteristics

V_{EE} = −4.2V to −5.7V, V_{CC} = GND, V_{TTL} = +4.5V to +5.5V

Symbol	Parameter	T_C = 0°C		T_C = +25°C		T_C = +85°C		Units	Conditions
		Min	Max	Min	Max	Min	Max		
t_{PLH} t_{PHL}	Propagation Delay Data to Output	0.80	3.50	0.90	3.70	1.00	4.00	ns	C_L = 15 pF *Figures 1* and *2*
t_{PLH} t_{PHL}	Propagation Delay Data to Output	1.60	4.30	1.70	4.50	1.80	4.80	ns	C_L = 50 pF *Figures 1* and *3*

PCC and Cerpak AC Electrical Characteristics

V_{EE} = −4.2V to −5.7V, V_{CC} = GND, V_{TTL} = +4.5V to +5.5V

Symbol	Parameter	T_C = 0°C		T_C = +25°C		T_C = +85°C		Units	Conditions
		Min	Max	Min	Max	Min	Max		
t_{PLH} t_{PHL}	Propagation Delay Data to Output	0.80	3.30	0.90	3.50	1.00	3.80	ns	C_L = 15 pF *Figures 1* and *2*
t_{PLH} t_{PHL}	Propagation Delay Data to Output	1.60	4.10	1.70	4.30	1.80	4.60	ns	C_L = 50 pF *Figures 1* and *3*
$t_{S\ G\text{-}G}$	Skew Gate to Gate		TBD		TBD		TBD	ps	PCC only (Note 1)

Note 1: Gate to gate skew is defined as the difference in the propagation delays between each of the outputs.

Truth Table

Inputs		Outputs
D_n	$\overline{D}_n$	Q_n
L	H	L
H	L	H
L	L	L
H	H	L
Open	Open	L
V_{EE}	V_{EE}	L
L	V_{BB}	L
H	V_{BB}	H
V_{BB}	L	H
V_{BB}	H	L

H = HIGH Voltage Level
L = LOW Voltage Level

Military Version—Preliminary

DC Electrical Characteristics

V_{EE} = −4.2V to −5.7V, V_{CC} = V_{CCA} = GND, T_C = −55°C to +125°C, C_L = 50 pF, V_{TTL} = +4.5V to +5.5V

Symbol	Parameter	Min	Max	Units	T_C	Conditions		Notes
V_{BB}	Output Reference Voltage	−1380	−1260	mV	−55°C to +125°C	I_{VBB} = −3 μA, V_{EE} = −4.2V I_{VBB} = −2.1 mA, V_{EE} = −5.7V		1, 2, 3
V_{IH}	Input HIGH Voltage	−1165	−870	mV	−55°C to +125°C	Guaranteed HIGH Signal for All Inputs (with One Input Tied to V_{BB})		1, 2, 3, 4
V_{IL}	Input LOW Voltage	−1830	−1475	mV	−55°C to +125°C	Guaranteed LOW Signal for All Inputs (with One Input Tied to V_{BB})		1, 2, 3, 4
V_{OH}	Output HIGH Voltage	2.5 2.4		mV	0°C to +125°C −55°C	I_{OH} = −2.0 mA	V_{IN} = $V_{IH\ (Max)}$ or $V_{IL\ (Min)}$	1, 2, 3
V_{OL}	Output LOW Voltage		0.5	mV	−55°C to +125°C	I_{OL} = 20 mA		
V_{DIFF}	Input Voltage Differential	150		mV	−55°C to +125°C	Required for Full Output Swing		1, 2, 3
V_{CM}	Common Mode Voltage	−2000	−500	mV	−55°C to +125°C			1, 2, 3, 4
I_{IH}	Input HIGH Current		350 500	μA	0°C to +125°C −55°C	V_{IN} = $V_{IH\ (Max)}$, D_0–D_5 = V_{BB}, $\overline{D_0}$–$\overline{D_5}$ = $V_{IL\ (Min)}$		1, 2, 3
I_{IL}	Input LOW Current	0.50		μA	−55°C to +125°C	V_{IN} = $V_{IL\ (Min)}$, D_0–D_5 = V_{BB}		1, 2, 3
I_{OS}	Output Short Circuit Current	−150	−60	mA	−55°C to +125°C	V_{OUT} = GND Test One Output at a Time		1, 2, 3
I_{CEX}	Output HIGH Leakage Current		250	μA	−55°C to +125°C	V_{OUT} = 5.5V		1, 2, 3
I_{EE}	V_{EE} Power Supply Current	−35	−12	mA	−55°C to +125°C	D_0–D_5 = V_{BB}		1, 2, 3
I_{TTL}	V_{TTL} Power Supply Current		65	mA	−55°C to +125°C	D_0–D_5 = V_{BB}		1, 2, 3

Note 1: F100K 300 Series cold temperature testing is performed by temperature soaking (to guarantee junction temperature equals −55°C), then testing immediately without allowing for the junction temperature to stabilize due to heat dissipation after power-up. This provides "cold start" specs which can be considered a worst case condition at cold temperatures.

Note 2: Screen tested 100% on each device at −55°C, +25°C, and +125°C, Subgroups 1, 2, 3, 7, and 8.

Note 3: Sample tested (Method 5005, Table I) on each manufactured lot at −55°C, + 25°C, and +125°C, Subgroups A1, 2, 3, 7, and 8.

Note 4: Guaranteed by applying specified input condition and testing V_{OH}/V_{OL}.

Ceramic Dual-In-Line Package AC Electrical Characteristics

V_{EE} = −4.2V to −5.7V, V_{CC} = GND, V_{TTL} = +4.5V to +5.5V

Symbol	Parameter	T_C = −55°C		T_C = +25°C		T_C = +125°C		Units	Conditions	Notes
		Min	Max	Min	Max	Min	Max			
t_{PLH} t_{PHL}	Propagation Delay Data to Output	1.50	5.00	1.60	4.70	1.70	5.70	ns	C_L = 50 pF *Figures 1* and *3*	1, 2, 3

Cerpak AC Electrical Characteristics

V_{EE} = −4.2V to −5.7V, V_{CC} = GND, V_{TTL} = +4.5V to +5.5V

Symbol	Parameter	T_C = −55°C		T_C = +25°C		T_C = +125°C		Units	Conditions	Notes
		Min	Max	Min	Max	Min	Max			
t_{PLH} t_{PHL}	Propagation Delay Data to Output	1.50	5.00	1.60	4.70	1.70	5.70	ns	C_L = 50 pF *Figures 1* and *3*	1, 2, 3

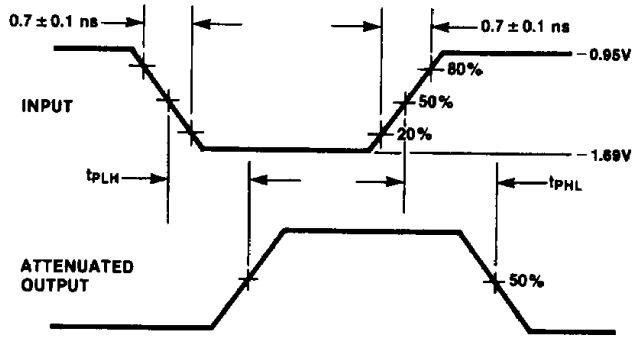
Note 1: F100K 300 Series cold temperature testing is performed by temperature soaking (to guarantee junction temperature equals −55°C), then testing immediately after power-up. This provides "cold start" specs which can be considered a worst case condition at cold temperatures.

Note 2: Screen tested 100% on each device at +25°C, temperature only, Subgroup A9.

Note 3: Sample tested (Method 5005, Table I) on each manufactured lot at +25°C, Subgroup A9, and at +125°C and −55°C temperatures, Subgroups A10 and A11.

Note 4: Not tested at +25°C, +125°C, and −55°C temperature (design characterization data).

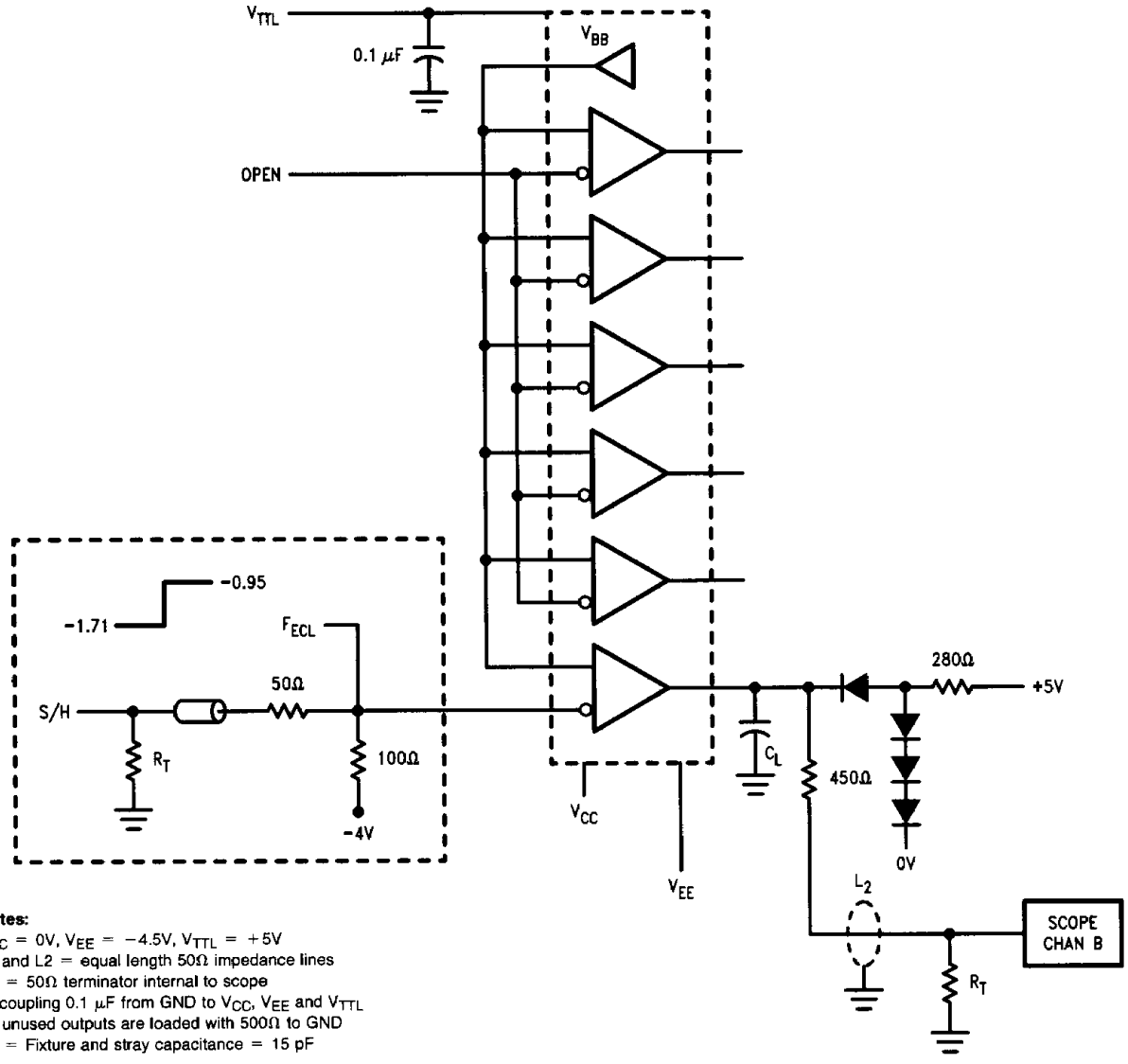
Switching Waveform



TL/F/9879–6

FIGURE 1. Propagation Delay

Test Circuits

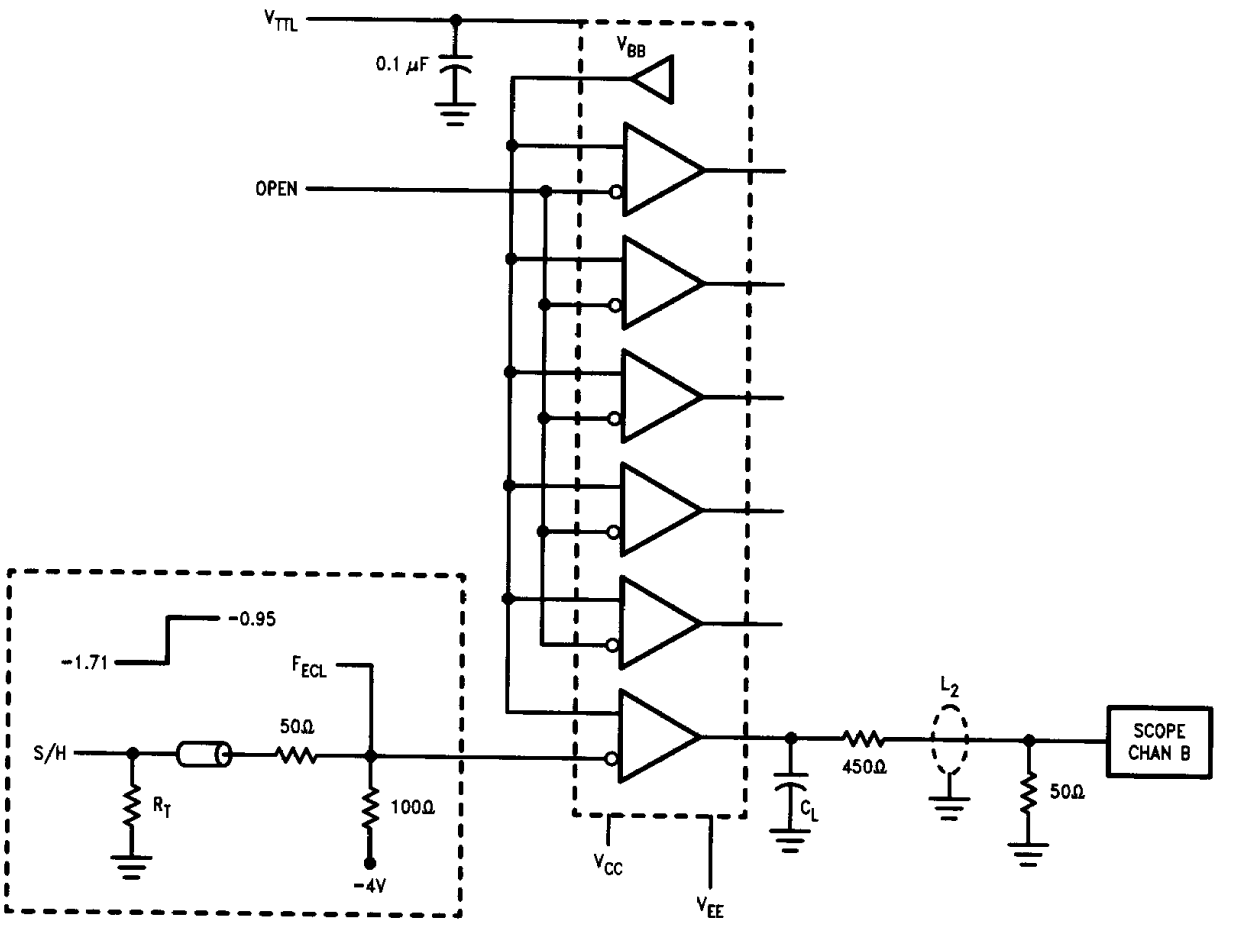


Notes:
V_{CC} = 0V, V_{EE} = −4.5V, V_{TTL} = +5V
L1 and L2 = equal length 50Ω impedance lines
R_T = 50Ω terminator internal to scope
Decoupling 0.1 μF from GND to V_{CC}, V_{EE} and V_{TTL}
All unused outputs are loaded with 500Ω to GND
C_L = Fixture and stray capacitance = 15 pF

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FIGURE 2. AC Test Circuit for 15 pF Loading

Test Circuits (Continued)



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FIGURE 3. AC Test Circuit for 50 pF Loading

Notes:
V_{CC} = 0V, V_{EE} = −4.5V, V_{TTL} = +5V
L1 and L2 = equal length 50Ω impedance lines
R_T = 50Ω terminator internal to scope
Decoupling 0.1 μF from GND to V_{CC}, V_{EE} and V_{TTL}
All unused outputs are loaded with 500Ω to GND
C_L = Fixture and stray capacitance = 50 pF

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